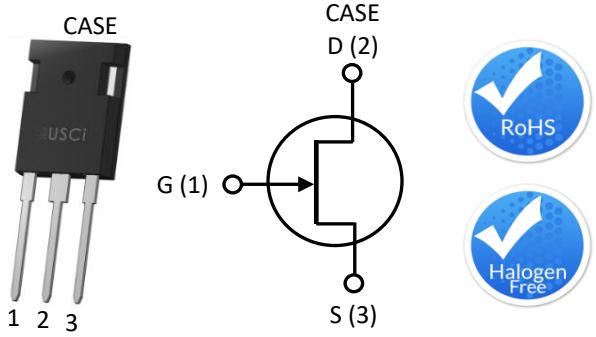
Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at V_{GS} = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N065080K3S	TO-247-3L	UJ3N065080K3S

Features

- Typical on-resistance $R_{DS(on),typ}$ of 80mΩ
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V_{DS}		650	V
Gate-source voltage	V_{GS}	DC	-20 to +3	V
		AC (1)	-20 to +20	
Continuous drain current (2)	I_D	T_C = 25°C	32	A
		T_C = 100°C	24	A
Pulsed drain current (3)	I_{DM}	T_C = 25°C	72	A
Power dissipation	P_{tot}	T_C=25°C	190	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	T_J, T_{STG}		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T_L		250	°C

(1) +20V AC rating applies for turn-on pulses <200ns applied with external R_G > 1Ω.
(2) Limited by $T_{J,max}$
(3) Pulse width t_p limited by $T_{J,max}$

Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Drain-source breakdown voltage	BV_{DS}	V_{GS}= - 20V, I_D=1mA	650			V
Total drain leakage current	I_D	V_{DS} = 650V, V_{GS} = -20V, T_J = 25°C		8	60	μA
		V_{DS} = 650V, V_{GS} = -20V, T_J = 175°C		30		
Total gate leakage current	I_G	V_{GS}=-20V, T_j=25°C		10	50	μA
		V_{GS}=-20V, T_j=175°C		32		
Drain-source on-resistance	$R_{DS(on)}$	V_{GS}=2V, I_D=10A, T_J = 25°C		68		mΩ
		V_{GS}=0V, I_D=10A, T_J = 25°C		80	95	
		V_{GS}=2V, I_D=10A, T_J = 175°C		114		
		V_{GS}=0V, I_D=10A, T_J = 175°C		130		
Gate threshold voltage	$V_{G(th)}$	V_{DS} = 5V, I_D = 20mA	-14	-11.5	-6	V
Gate resistance	R_G	f = 1MHz, open drain		3.7		Ω

Typical Performance - Dynamic

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Input capacitance	C_{iss}	V_{DS} = 100V, V_{GS} = -20V, f = 100kHz		630		pF
Output capacitance	C_{oss}			94		
Reverse transfer capacitance	C_{rss}			88		
Effective output capacitance, energy related	$C_{oss(er)}$	V_{DS} = 0V to 400V, V_{GS} = -20V		69		pF
Total gate charge	Q_G	V_{DS}=400V, I_D = 24A, V_{GS}=-18V to 0V		75		nC
Gate-drain charge	Q_{GD}			43		
Gate-source charge	Q_{GS}			7		
Turn-on delay time	$t_{d(on)}$	V_{DS}=400V, I_D=24A, Gate Driver =-18V to 0V, $R_{G,EXT}$ = 1Ω, Inductive Load, FWD: UJ3D06510TS T_J = 25°C		6		ns
Rise time	t_r			25		
Turn-off delay time	$t_{d(off)}$			14		
Fall time	t_f			31		
Turn-on energy	E_{ON}			149		μJ
Turn-off energy	E_{OFF}			183		
Total switching energy	E_{TOTAL}			332		
Turn-on delay time	$t_{d(on)}$	V_{DS}=400V, I_D=24A, Gate Driver =-18V to 0V, $R_{G,EXT}$ = 1Ω, Inductive Load, FWD: UJ3D06510TS T_J = 150°C		6		ns
Rise time	t_r			24		
Turn-off delay time	$t_{d(off)}$			14		
Fall time	t_f			14		
Turn-on energy	E_{ON}			134		μJ
Turn-off energy	E_{OFF}			103		
Total switching energy	E_{TOTAL}			237		

Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Typ	Max	
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.61	0.79	°C/W

Typical Performance Diagrams

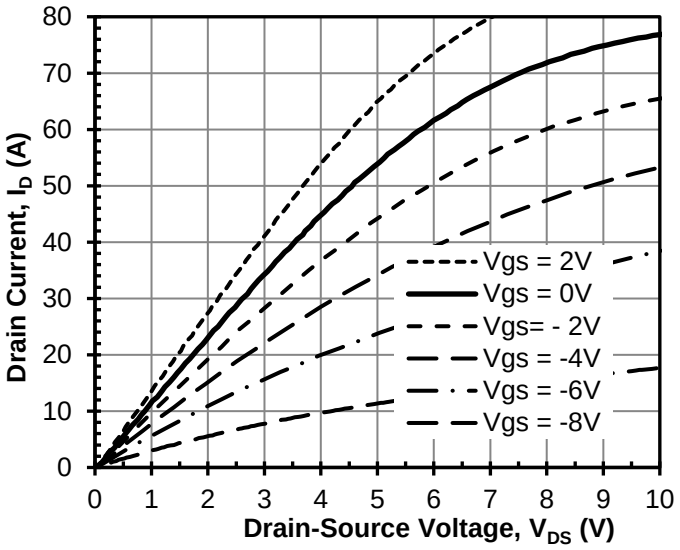


Figure 1 Typical output characteristics at T_J = 55°C

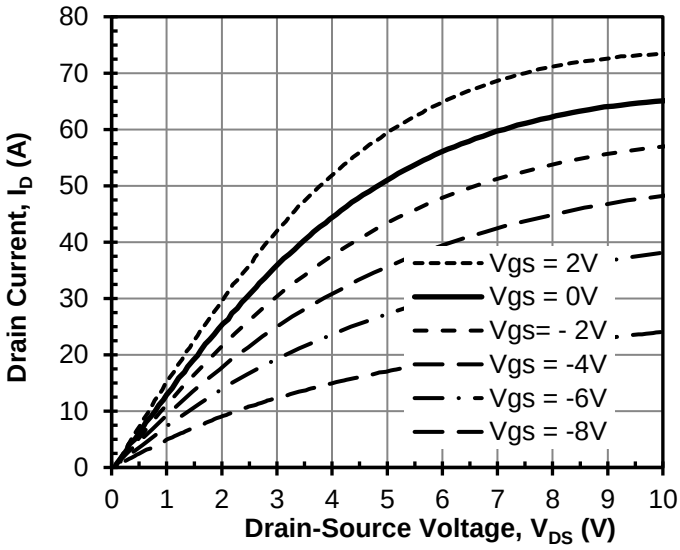


Figure 2 Typical output characteristics at T_J = 25°C

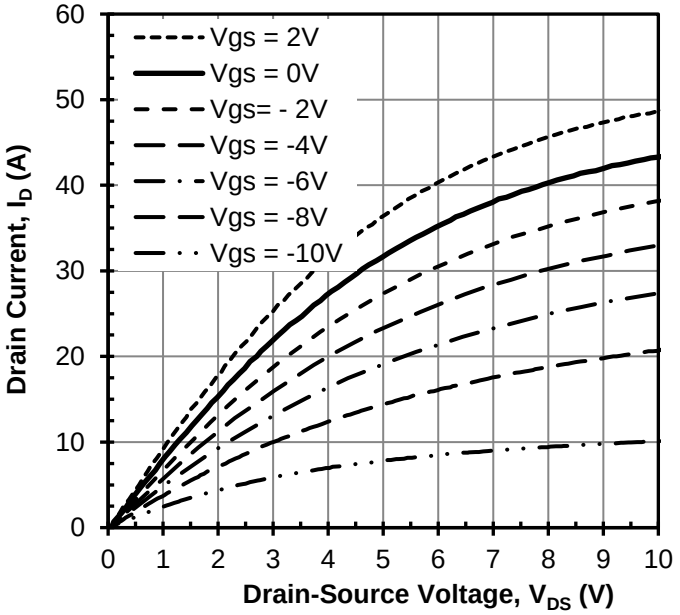


Figure 3 Typical output characteristics at T_J = 175°C

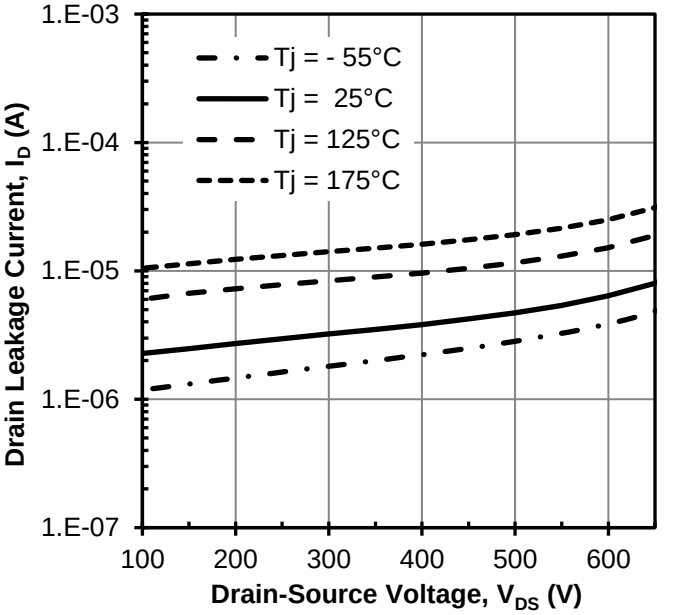


Figure 4 Typical drain-source leakage at V_{GS} = -20V

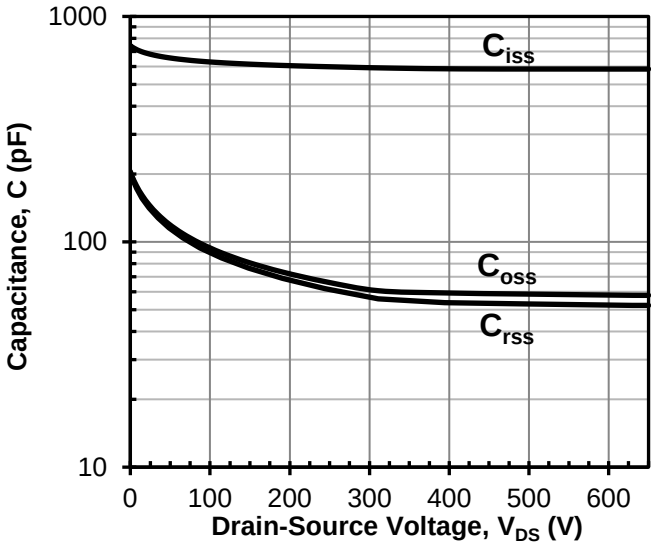


Figure 5 Typical capacitances at 100kHz and V_{GS} = -20V

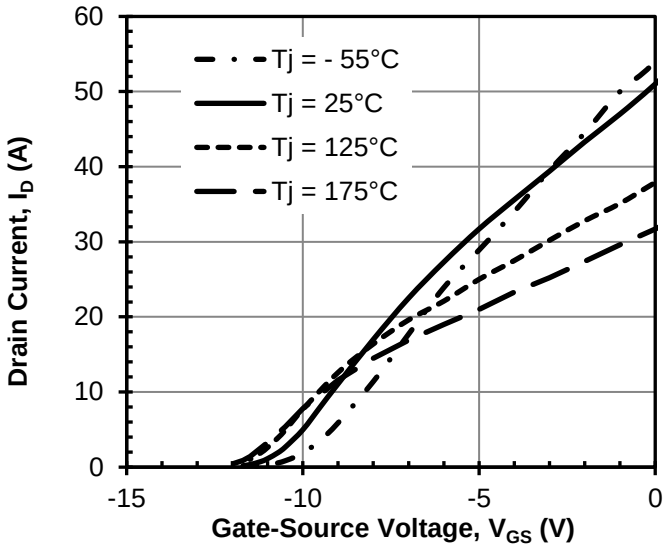


Figure 6 Typical transfer characteristics at V_{DS} = 5V

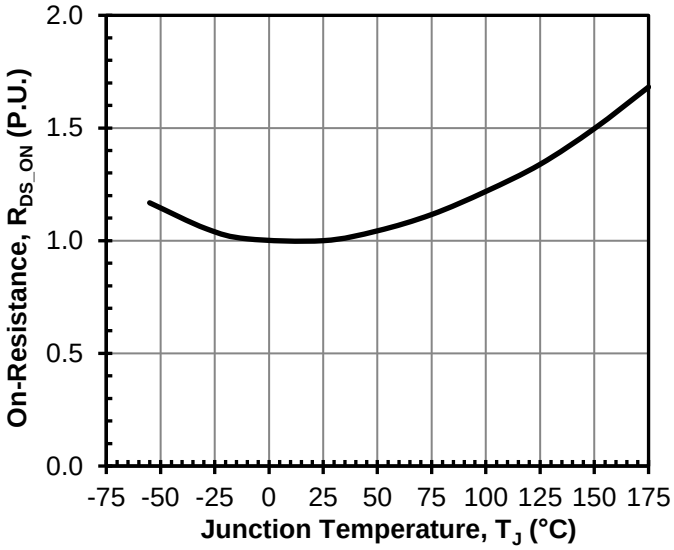


Figure 7 Normalized on-resistance vs. temperature at V_{GS} = 0V and I_D = 10A

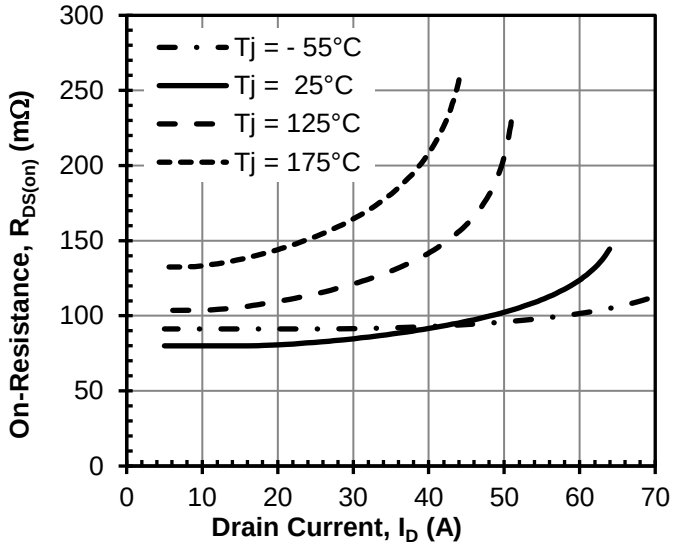


Figure 8 Typical drain-source on-resistance at V_{GS} = 0V

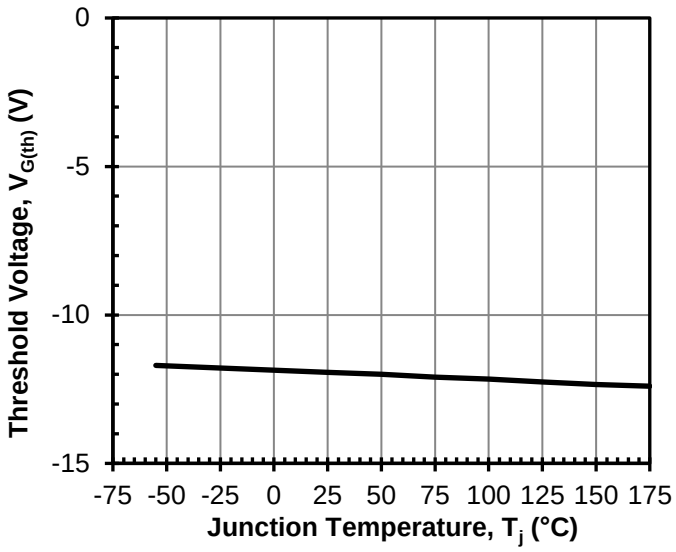


Figure 9 Threshold voltage vs. Tj at V_{DS} = 5V and I_D = 20mA

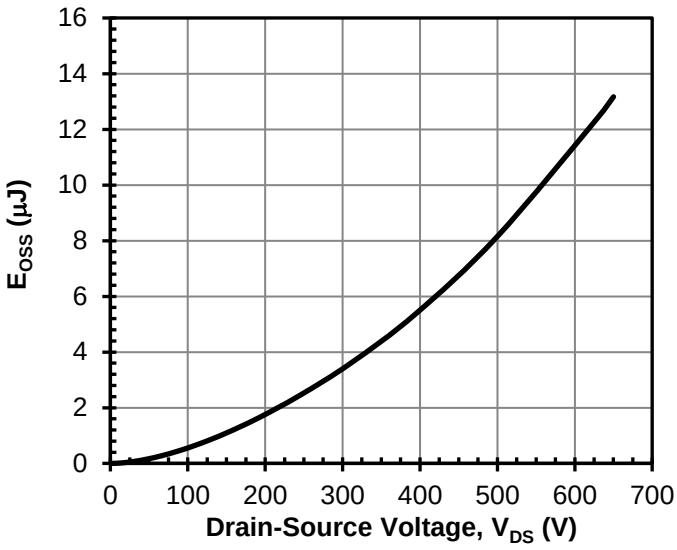


Figure 10 Typical stored energy in C_{OSS} at V_{GS} = -20V

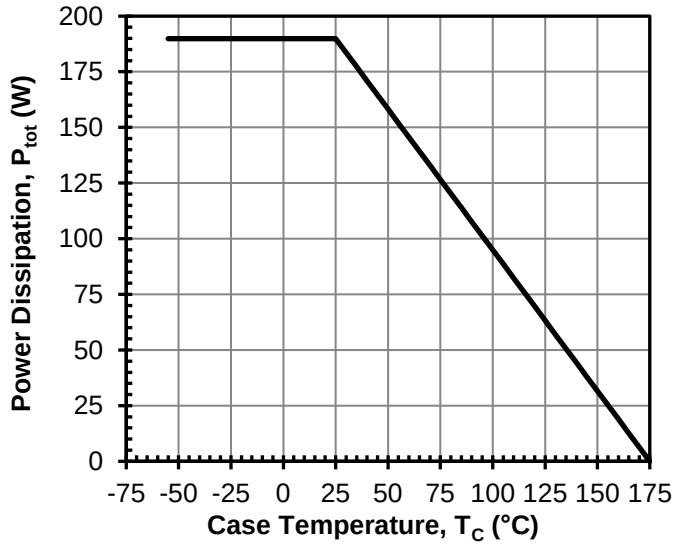


Figure 11 Total power Dissipation

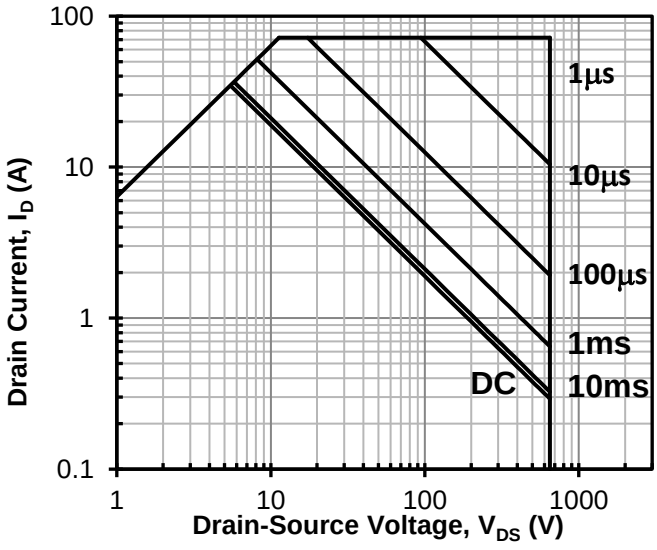


Figure 12 Safe operation area T_c = 25°C, Parameter t_p

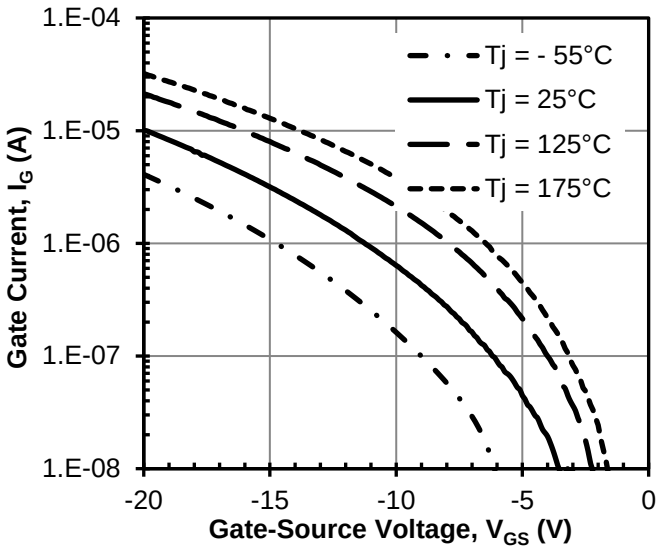


Figure 13 Typical gate leakage current at V_{DS} = 0V

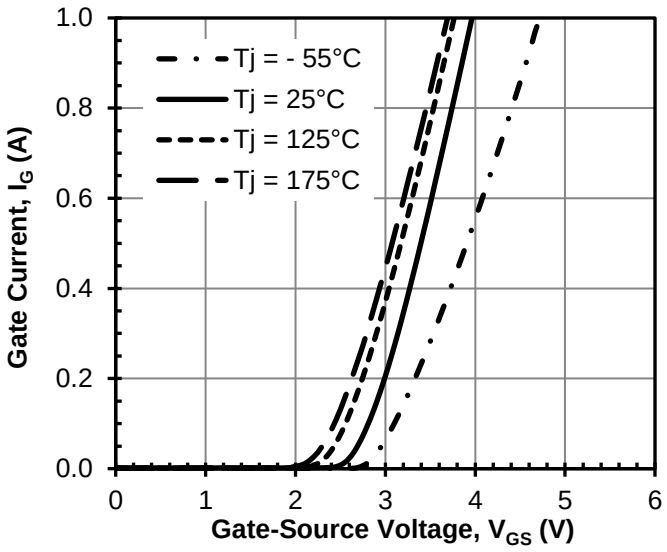


Figure 14 Typical gate forward current at V_{DS} = 0V

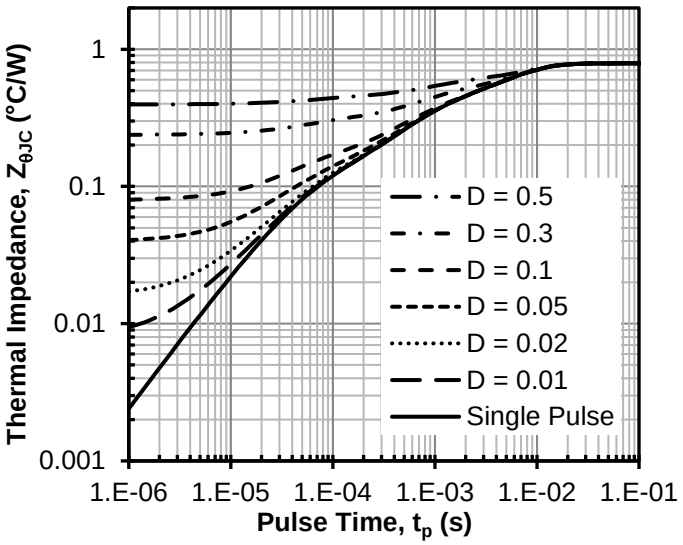


Figure 15 Maximum transient thermal impedance

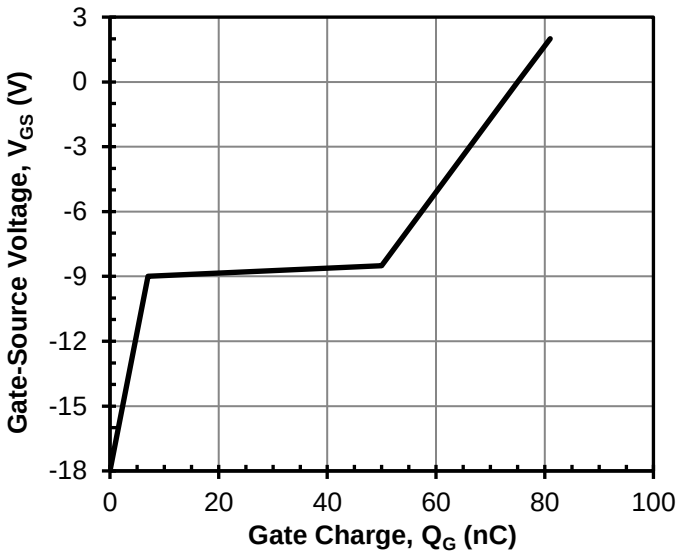


Figure 16 Typical gate charge at V_{DS} = 400V and I_D = 24A

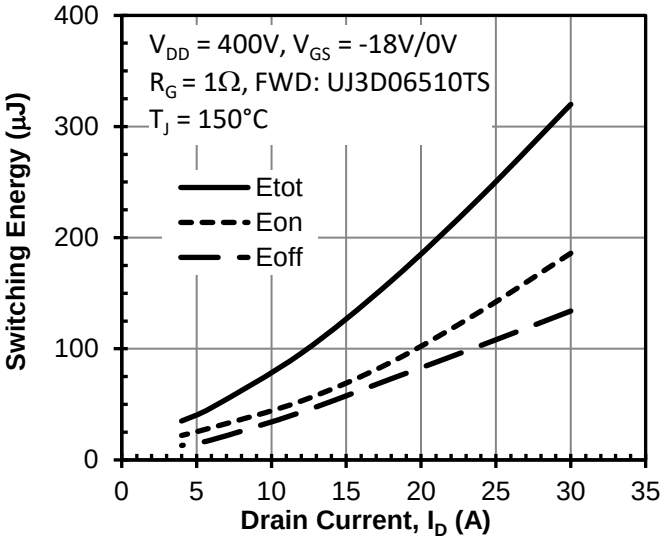


Figure 17 Clamped inductive switching energy vs. drain current at T_J = 150°C

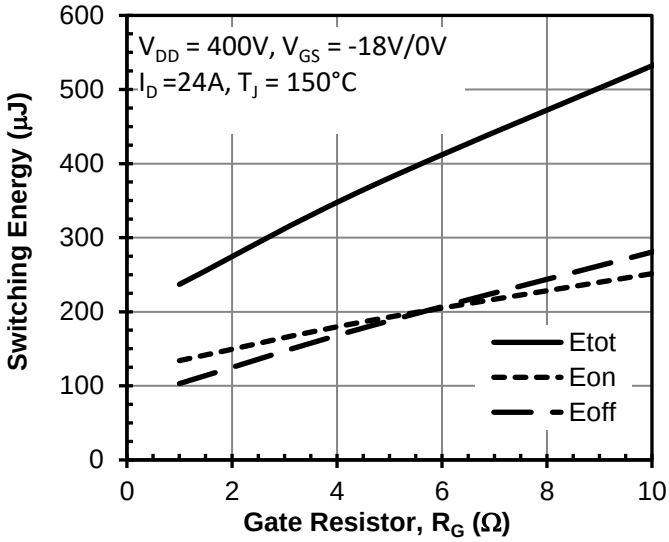


Figure 18 Clamped inductive switching turn-off energy vs. gate resistor R_G

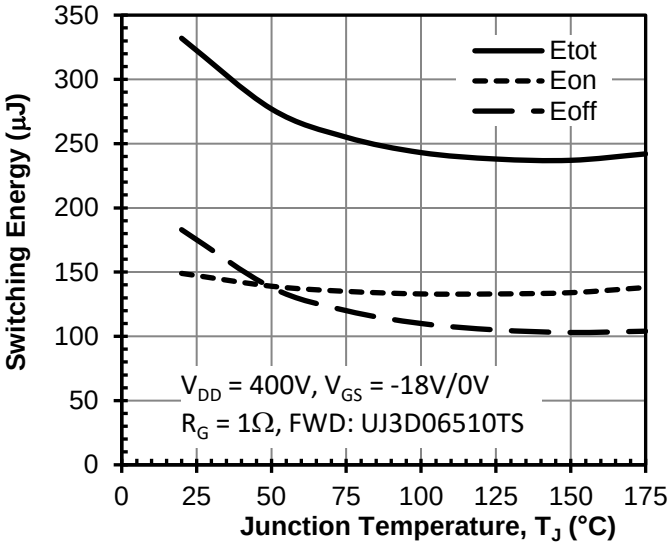


Figure 19 Clamped inductive switching energy vs. junction temperature at I_D = 24A

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